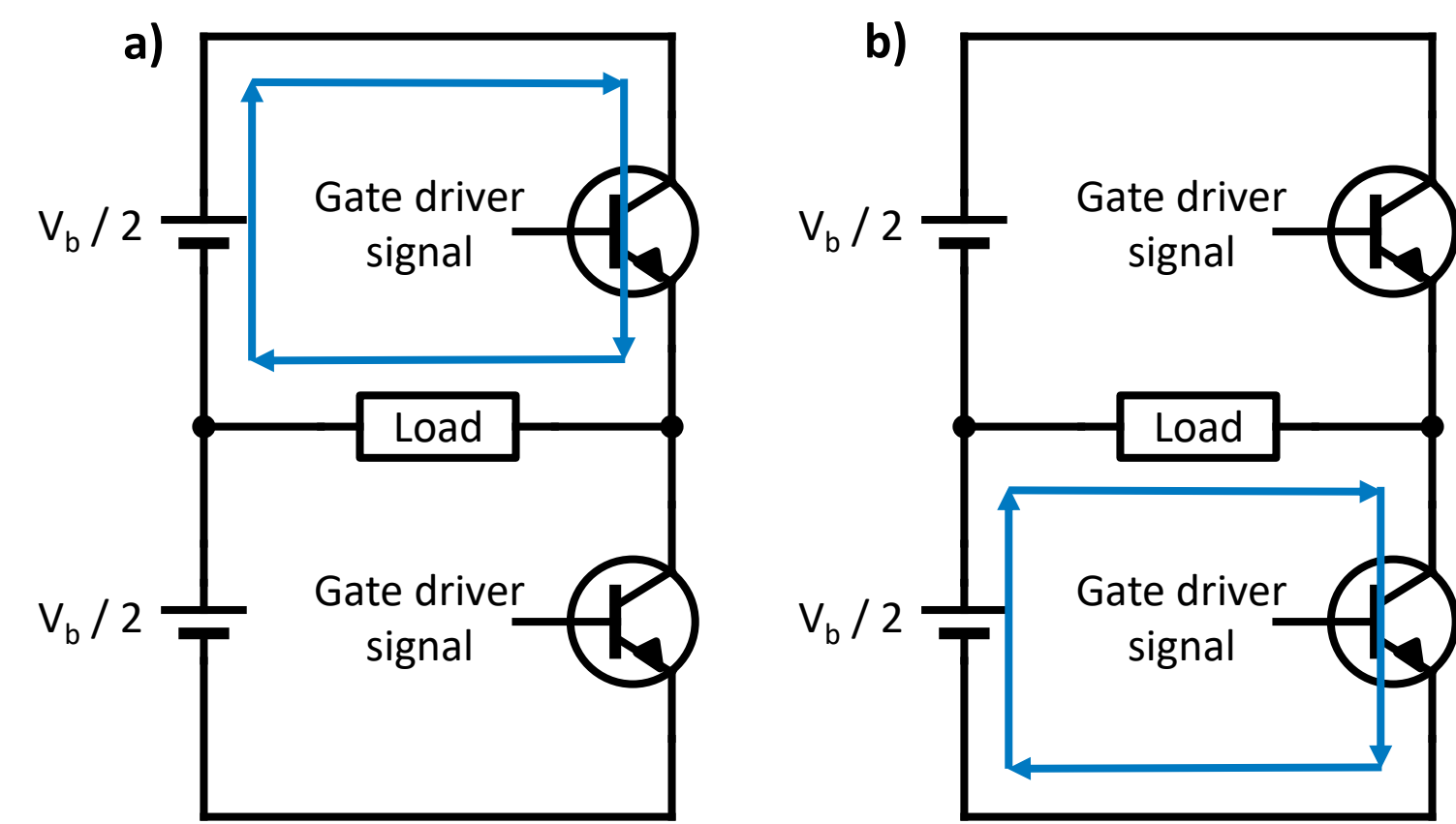


## Introduction

Maximizing efficiency in electric vehicles (EVs) is critical to fully replacing gas-powered vehicles. A key focus area for improving efficiency in EVs is in the components responsible for electricity transmission throughout the vehicle, especially the **power inverter**.

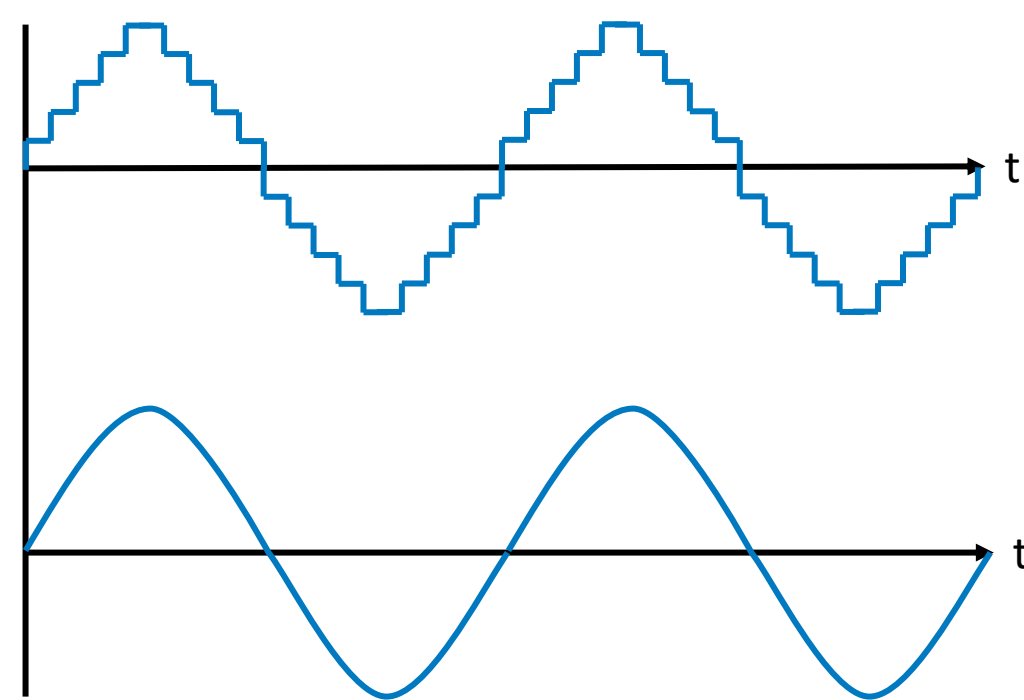
### What does an EV inverter module do?

- Converts DC power from the batteries into AC, used by the high-current induction motors
- One half-bridge inverter module uses at least one pair of Silicon Carbide (SiC) Metal Oxide Semiconductor Field Effect Transistors (MOSFETs) to convert battery DC to AC



Current flow through half-bridge inverter circuit when a) the upper and b) the lower MOSFETs are closed, producing an alternating signal at the load

- The MOSFETs rapidly switch on and off on the to produce a smooth sinusoidal AC signal



Graphical representation of how a sinusoidal AC waveform can be generated by rapid toggling of MOSFETs

- Faster switching speed** improves motor efficiency and minimizes switching losses, but simultaneously introduces harmful parasitic inductance as a result of the rapid changes in voltage and current ( $dV/dt$  and  $dI/dt$ )<sup>1</sup>
- This unwanted inductance can cause damage to the inverter or other components and thus it is critical to **reduce this inductance** as much as possible

**Project Goal:** Design equipment and develop a control mechanism to facilitate the fabrication of novel power inverter modules with innovative designs and materials, allowing for rapid module prototyping and simulation validation.

## Press Design



Press assembly



Press baseplate with embedded ceramic heater cartridges and pressure sensor as seen from behind

### Key Features

- High-torque DC motors capable of supplying 5000+ Newtons of force
- Pressure sensor built into baseplate to monitor force reading and provide feedback to motor control
- Self-leveling baseplate to ensure even pressure distribution onto sample
- Custom-built temperature controller to heat baseplate to desired temperature
- Intuitive graphical Python program to control press operation and monitor program status
- Built-in redundant temperature safeties to ensure that baseplate temperature never exceeds user setpoint

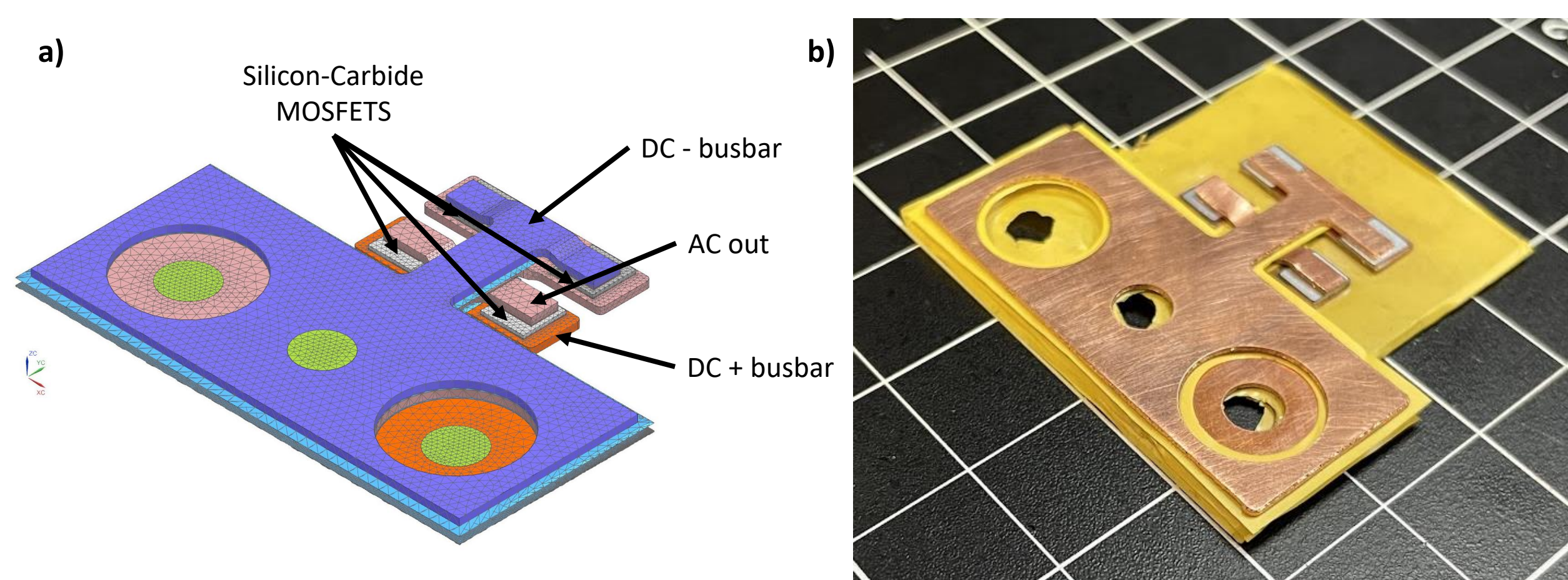
## Module Design

### Issues with traditional power inverter modules

- 2D layout with wire-bonded connections result in energy density limitations and minimal reduction in parasitic inductance
- Ceramic substrate is expensive and difficult to modify post-production, limiting module design possibilities

### New inverter design

- Replacing ceramic substrate with Dupont™ Temprion® electrically insulating film
- Stacked module layout greatly improves energy density and reduces parasitic inductance<sup>2</sup> (based on simulation data)
  - Typical half-bridge module inductance: **20-25 nH**
  - Novel half-bridge module inductance: **8.2-9.5 nH**
- Improved reliability as the compliance of Temprion® reduces the strain caused by the coefficient of thermal expansion (CTE)



a) 3D CAD drawing of new half-bridge inverter module and b) early prototype module built using the updated press program

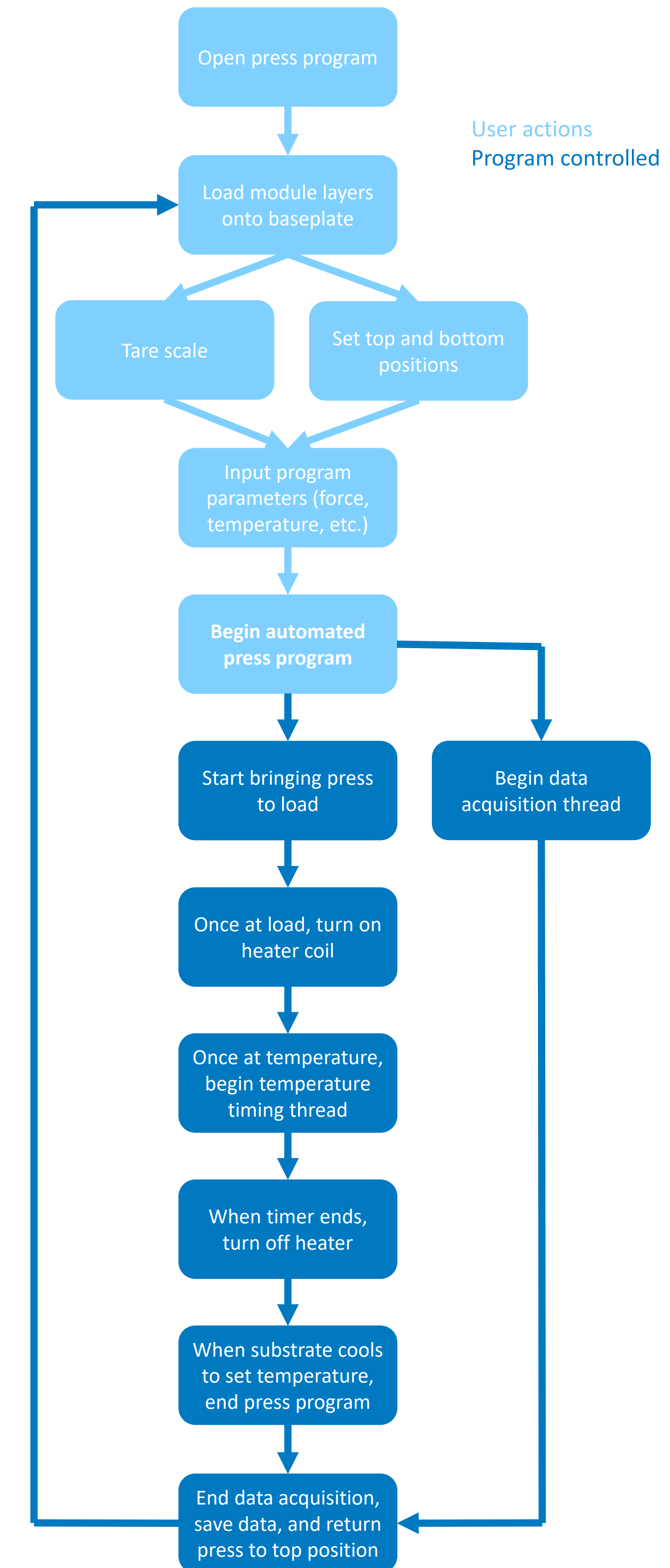
## Conclusion

- Press is working as desired for fabrication of new modules utilizing Temprion® as an insulating substrate material
- Speed of construction of new modules allows for rapid verification of simulation data
- Relatively inexpensive component costs and ease of fabrication have promising potential for widespread adoption of this material and process into a variety of research areas

## Future Work

- Develop a method of consistently placing and aligning layers within press stack to ensure repeatability of module fabrication
- Incorporate heating element into top plate of press to allow for double-sided heating and decrease module fabrication time
  - Press currently contains heating only in the baseplate, limiting the rate of bonding to one layer at a time
  - Double-sided heating could allow for the entire module to be pressed at once
- Implement control of vacuum chamber into press program to allow for fabrication of modules under varying environmental conditions
- Characterize electromagnetic properties of new inverter module to direct future research focus

## Program Workflow



Press program workflow, where actions in light blue are performed by the user and dark blue are completed by the program

## Acknowledgements

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## References

- <sup>1</sup> S. Wang, R. Pollock, N. McNeill, D. Holliday, K. Ahmed, and B. Williams, "Realising SiC MOSFET switching speed control based on a novel series variable-resistance gate driver", in 11th international conference on power electronics, machines and drives (PEMD 2022), Vol. 2022 (June 2022), pp. 588–592.
- <sup>2</sup> H. Gui, R. Chen, J. Niu, Z. Zhang, F. Wang, L. M. Tolbert, D. J. Costinett, B. J. Blalock, and B. B. Choi, "Design of low inductance busbar for 500 kVA three-level ANPC converter", in 2019 IEEE energy conversion congress and exposition (ECCE), ISSN: 2329-3748 (Sept. 2019), pp. 7130–7137.